

SN74GTL16622A 18-BIT LVTTL-TO-GTL/GTL+ BUS TRANSCEIVER

SCBS673F – AUGUST 1996 – REVISED AUGUST 2001

- Member of Texas Instruments' Widebus™ Family
- OEC™ Circuitry Improves Signal Integrity and Reduces Electromagnetic Interference
- D-Type Flip-Flops With Qualified Storage Enable
- Translates Between GTL/GTL+ Signal Levels and LVTTL Logic Levels
- Supports Mixed-Mode (3.3 V and 5 V) Signal Operation on A-Port and Control Inputs
- I_{off} Supports Partial-Power-Down Mode Operation
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors on A Port
- Distributed V_{CC} and GND Pins Minimize High-Speed Noise
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

**DGG PACKAGE
(TOP VIEW)**

<u>OEAB</u>	1	64	<u>CLKAB</u>
1A1	2	63	<u>1CEAB</u>
GND	3	62	<u>1CEBA</u>
1A2	4	61	1B1
1A3	5	60	GND
GND	6	59	1B2
V _{CC}	7	58	1B3
1A4	8	57	V _{CC}
GND	9	56	1B4
1A5	10	55	1B5
1A6	11	54	1B6
GND	12	53	GND
1A7	13	52	1B7
1A8	14	51	1B8
GND	15	50	GND
1A9	16	49	1B9
2A1	17	48	2B1
GND	18	47	GND
2A2	19	46	2B2
2A3	20	45	2B3
GND	21	44	GND
2A4	22	43	2B4
2A5	23	42	2B5
GND	24	41	2B6
2A6	25	40	V _{REF}
V _{CC}	26	39	2B7
GND	27	38	2B8
2A7	28	37	GND
2A8	29	36	2B9
GND	30	35	<u>2CEBA</u>
2A9	31	34	<u>2CEAB</u>
<u>OEBA</u>	32	33	<u>CLKBA</u>

description

The SN74GTL16622A is an 18-bit registered bus transceiver that provides LVTTL-to-GTL/GTL+ and GTL/GTL+-to-LVTTL signal-level translation. This device is partitioned as two separate 9-bit transceivers with individual clock-enable controls and contains D-type flip-flops for temporary storage of data flowing in either direction. This device provides an interface between cards operating at LVTTL logic levels and a backplane operating at GTL/GTL+ signal levels. Higher speed operation is a direct result of the reduced output swing (<1 V), reduced input threshold levels, and OEC™ circuitry.

The user has the flexibility of using this device at either GTL (V_{TT} = 1.2 V and V_{REF} = 0.8 V) or the preferred higher noise margin GTL+ (V_{TT} = 1.5 V and V_{REF} = 1 V) signal levels. GTL+ is the Texas Instruments derivative of the Gunning Transceiver Logic (GTL) JEDEC standard JESD 8-3. The B port normally operates at GTL or GTL+ signal levels, while the A-port and control inputs are compatible with LVTTL logic levels and are 5-V tolerant. V_{REF} is the reference input voltage for the B port.



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description (continued)

Data flow in each direction is controlled by the output-enable (\overline{OEAB} and \overline{OEBA}) and clock (CLKAB and CLKBA) inputs. The clock-enable (\overline{CEAB} and \overline{CEBA}) inputs control each 9-bit transceiver independently, which makes the device more versatile.

For A-to-B data flow, the device operates on the low-to-high transition of CLKAB if \overline{CEAB} is low. When \overline{OEAB} is low, the outputs are active. When \overline{OEAB} is high, the outputs are in the high-impedance state. Data flow for B to A is similar to that of A to B, but uses \overline{OEBA} , CLKBA, and \overline{CEBA} .

This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

Active bus-hold circuitry holds unused or undriven LVTTTL inputs at a valid logic state. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
-40°C to 85°C	TSSOP – DGG	Tape and reel	SN74GTL16622ADGGR	GTL16622A

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE‡

INPUTS				OUTPUT B	MODE
\overline{CEAB}	\overline{OEAB}	CLKAB	A		
X	H	X	X	Z	Isolation
H	L	X	X	B_0^{\S}	Latched storage of A data
X	L	H or L	X	B_0^{\S}	
L	L	↑	L	L	Clocked storage of A data
L	L	↑	H	H	

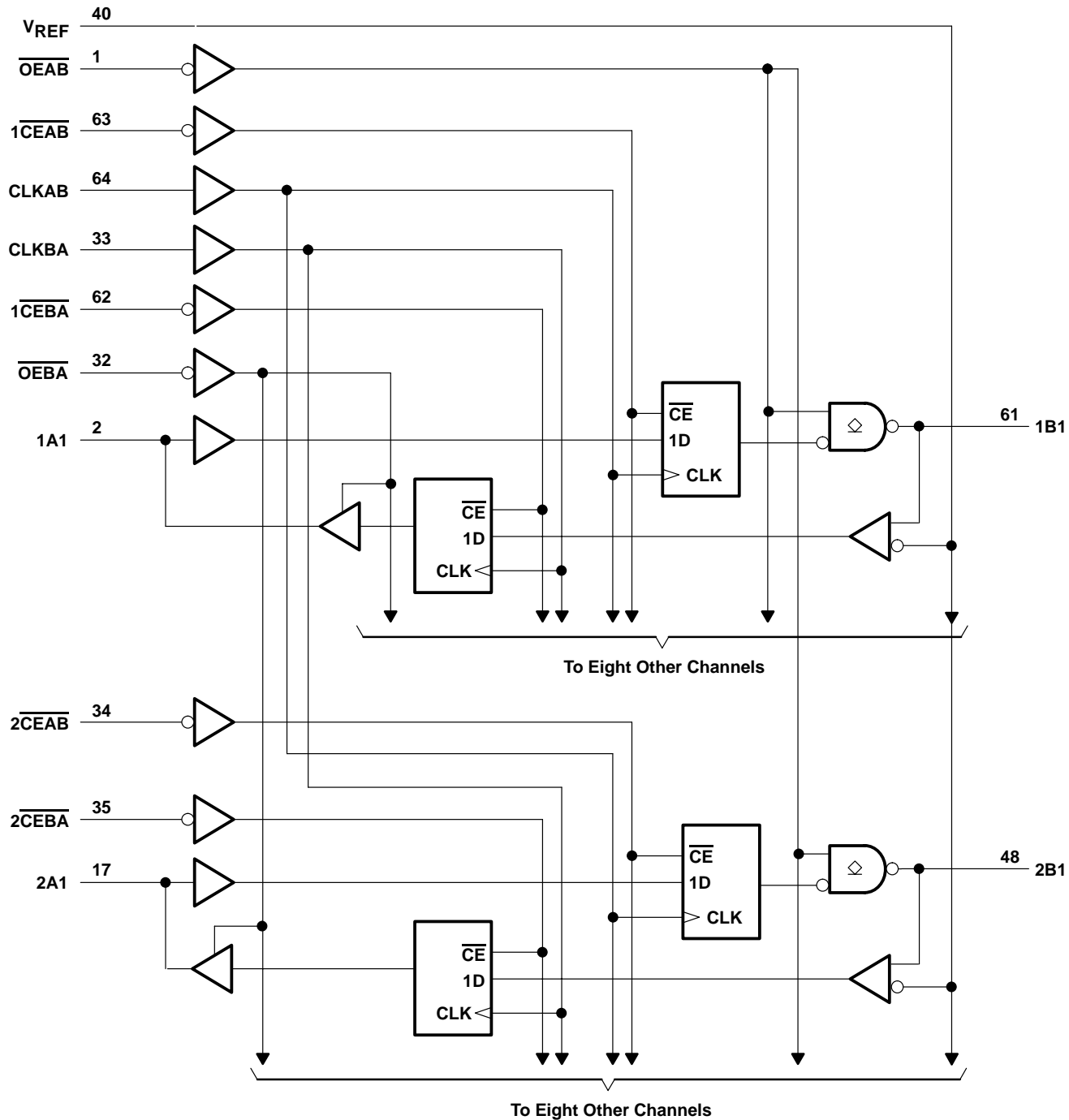
‡ A-to-B data flow is shown. B-to-A data flow is similar, but uses \overline{OEBA} , CLKBA, and \overline{CEBA} .

§ Output level before the indicated steady-state input conditions are established

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logic diagram (positive logic)



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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 4.6 V
Input voltage range, V_I (see Note 1): A-port and control inputs	–0.5 V to 6.5 V
B port and V_{REF}	–0.5 V to 4.6 V
Voltage range applied to any output in the high or power-off state, V_O	
(see Note 1): A port	–0.5 V to 6.5 V
B port	–0.5 V to 4.6 V
Current into any output in the low state, I_O : A port	48 mA
B port	100 mA
Current into any A-port output in the high state, I_O (see Note 2)	48 mA
Continuous current through each V_{CC} or GND	±100 mA
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$)	–50 mA
Package thermal impedance, θ_{JA} (see Note 3)	55°C/W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
 2. This current flows only when the output is in the high state and $V_O > V_{CC}$.
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions (see Notes 4 through 7)

		MIN	NOM	MAX	UNIT	
V_{CC}	Supply voltage	3.15	3.3	3.45	V	
V_{TT}	Termination voltage	GTL	1.14	1.2	1.26	V
		GTL+	1.35	1.5	1.65	
V_{REF}	Reference voltage	GTL	0.74	0.8	0.87	V
		GTL+	0.87	1	1.1	
V_I	Input voltage	B port	V_{TT}		V	
		Except B port	5.5			
V_{IH}	High-level input voltage	B port	$V_{REF}+50$ mV		V	
		Except B port	2			
V_{IL}	Low-level input voltage	B port	$V_{REF}-50$ mV		V	
		Except B port	0.8			
I_{IK}	Input clamp current			–18	mA	
I_{OH}	High-level output current	A port		–24	mA	
I_{OL}	Low-level output current	A port		24	mA	
		B port		50		
T_A	Operating free-air temperature	–40		85	°C	

- NOTES: 4. All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
 5. Normal connection sequence is GND first and $V_{CC} = 3.3$ V, I/O, control inputs, V_{TT} and V_{REF} (any order) last.
 6. V_{TT} and R_{TT} can be adjusted to accommodate backplane impedances if the dc recommended I_{OL} ratings are not exceeded.
 7. V_{REF} can be adjusted to optimize noise margins, but normally is two-thirds V_{TT} .



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electrical characteristics over recommended operating free-air temperature range for GTL/GTL+ (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP†	MAX	UNIT	
V_{IK}		$V_{CC} = 3.15\text{ V}$, $I_I = -18\text{ mA}$				-1.2	V	
V_{OH}	A port	$V_{CC} = 3.15\text{ V to }3.45\text{ V}$, $I_{OH} = -100\text{ }\mu\text{A}$		$V_{CC}-0.2$			V	
		$V_{CC} = 3.15\text{ V}$	$I_{OH} = -12\text{ mA}$		2.4			
			$I_{OH} = -24\text{ mA}$		2			
V_{OL}	A port	$V_{CC} = 3.15\text{ V to }3.45\text{ V}$, $I_{OL} = 100\text{ }\mu\text{A}$				0.2	V	
		$V_{CC} = 3.15\text{ V}$	$I_{OL} = 12\text{ mA}$					0.4
			$I_{OL} = 24\text{ mA}$					0.5
	B port	$V_{CC} = 3.15\text{ V to }3.45\text{ V}$, $I_{OL} = 100\text{ }\mu\text{A}$				0.2		
		$V_{CC} = 3.15\text{ V}$	$I_{OL} = 10\text{ mA}$					0.2
			$I_{OL} = 40\text{ mA}$					0.4
		$I_{OL} = 50\text{ mA}$				0.55		
I_I	B port	$V_{CC} = 3.45\text{ V}$, $V_I = V_{TT}$ or GND				± 5	μA	
	A-port and control inputs	$V_{CC} = 3.45\text{ V}$		$V_I = V_{CC}$ or GND		± 5		
				$V_I = 5.5\text{ V}$ or GND		± 20		
I_{off}		$V_{CC} = 0$, V_I or $V_O = 0$ to 5.5 V				100	μA	
$I_I(\text{hold})$	A port	$V_{CC} = 3.15\text{ V}$		$V_I = 0.8\text{ V}$		75	μA	
				$V_I = 2\text{ V}$		-75		
		$V_{CC} = 3.45\text{ V}^\ddagger$		$V_I = 0.8\text{ V to }2\text{ V}$		± 500		
I_{OZ}^\S	A port	$V_{CC} = 3.45\text{ V}$, $V_O = V_{CC}$ or GND				± 10	μA	
I_{OZH}	B port	$V_{CC} = 3.45\text{ V}$, $V_O = 1.5\text{ V}$				10	μA	
I_{CC}	A or B port	$V_{CC} = 3.45\text{ V}$, $I_O = 0$, $V_I = V_{CC}$ or GND		Outputs high		60	mA	
				Outputs low		60		
				Outputs disabled		60		
ΔI_{CC}^\parallel		$V_{CC} = 3.45\text{ V}$, A-port or control inputs at V_{CC} or GND, One input at $V_{CC} - 0.6\text{ V}$				500	μA	
C_i	Control inputs	$V_I = 3.15\text{ V}$ or 0				2.5	3	pF
C_{io}	A port	$V_O = 3.15\text{ V}$ or 0				6	8	pF
	B port					6.5	8.5	

† All typical values are at $V_{CC} = 3.3\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

§ For I/O ports, the parameter I_{OZ} includes the input leakage current.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level rather than V_{CC} or GND.

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timing requirements over recommended ranges of supply voltage and operating free-air temperature for GTL (unless otherwise noted)

		MIN	MAX	UNIT
f_{clock}	Clock frequency		200	MHz
t_w	Pulse duration, CLK high or low	2.5		ns
t_{su}	Setup time	Data before CLK \uparrow	2.1	ns
		$\overline{\text{CE}}$ before CLK \uparrow	3.3	
t_h	Hold time	Data after CLK \uparrow	0.3	ns
		$\overline{\text{CE}}$ after CLK \uparrow	0	

switching characteristics over recommended ranges of supply voltage and operating free-air temperature for GTL (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	TYP†	MAX	UNIT
f_{max}			200			MHz
t_{PLH}	CLKAB	B	2.5		5.5	ns
t_{PHL}			2.2		5.5	
t_{dis}	$\overline{\text{OEAB}}$	B	1.7		4.8	ns
t_{en}			2.2		5.2	
Slew rate	Both transitions (B port)		0.5			V/ns
t_r	Transition time, B outputs (0.6 V to 1 V)		0.6		2.2	ns
t_f	Transition time, B outputs (1 V to 0.6 V)		0.4		1.5	ns
t_{PLH}	CLKBA	A	2.1		5.3	ns
t_{PHL}			2.1		5	
t_{en}	$\overline{\text{OEBA}}$	A	1.7		5	ns
t_{dis}			2.3		5.5	

† All typical values are at $V_{\text{CC}} = 3.3 \text{ V}$, $T_A = 25^\circ\text{C}$.



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timing requirements over recommended ranges of supply voltage and operating free-air temperature for GTL+ (unless otherwise noted)

		MIN	MAX	UNIT
f_{clock}	Clock frequency		200	MHz
t_w	Pulse duration, CLK high or low	2.5		ns
t_{su}	Setup time	Data before CLK \uparrow	2.4	ns
		$\overline{\text{CE}}$ before CLK \uparrow	3.2	
t_h	Hold time	Data after CLK \uparrow	0.2	ns
		$\overline{\text{CE}}$ after CLK \uparrow	0	

switching characteristics over recommended ranges of supply voltage and operating free-air temperature for GTL+ (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	MIN	TYP \dagger	MAX	UNIT
f_{max}			200			MHz
t_{PLH}	CLKAB	B	2.6	4	5.6	ns
t_{PHL}			2.3	4	5.7	
t_{PLH}	$\overline{\text{OEAB}}$	B	2.4	3.8	5.2	ns
t_{PHL}			1.8	3.4	5	
Slew rate	Both transitions (B port)		0.5			V/ns
t_r	Transition time, B outputs (0.6 V to 1.3 V)		1	1.6	2.7	ns
t_f	Transition time, B outputs (1.3 V to 0.6 V)		0.5	1.1	3.2	ns
t_{PLH}	CLKBA	A	2	3.8	5.3	ns
t_{PHL}			1.9	3.6	5	
t_{en}	$\overline{\text{OEBA}}$	A	1.9	3.6	5	ns
t_{dis}			2.1	4	5.5	

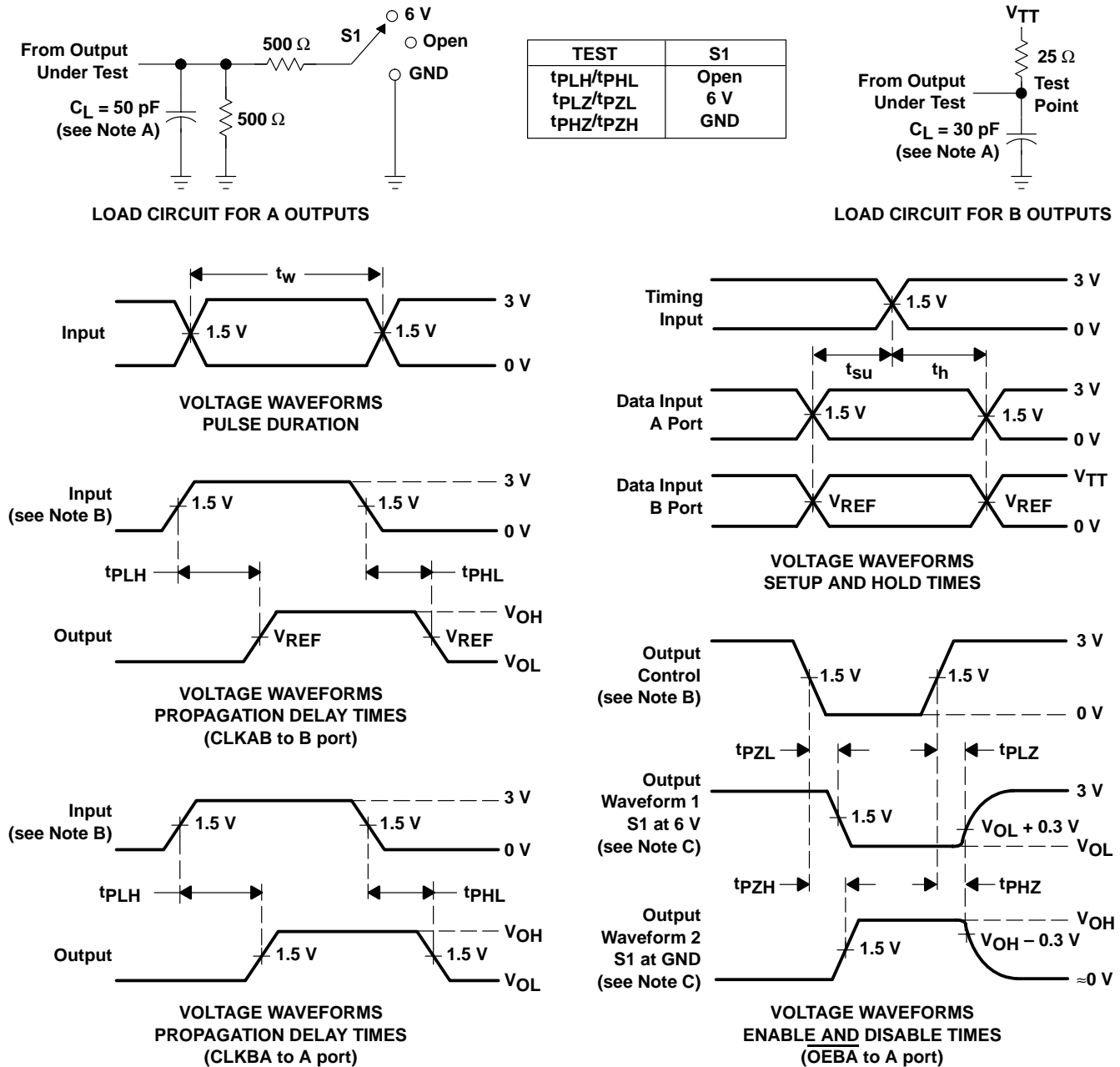
\dagger All typical values are at $V_{\text{CC}} = 3.3 \text{ V}$, $T_A = 25^\circ\text{C}$.

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PARAMETER MEASUREMENT INFORMATION



- NOTES:
- A. C_L includes probe and jig capacitance.
 - B. All input pulses are supplied by generators having the following characteristics: $PRR \leq 10 \text{ MHz}$, $Z_O = 50 \Omega$, $t_r \leq 2.5 \text{ ns}$, $t_f \leq 2.5 \text{ ns}$.
 - C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - D. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

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